

RELIABILITY MONITOR SAMPLING PLAN

<u>PRODUCT</u>	<u>FAMILY</u>	<u>TECHNOLOGY</u>	<u>ASSEMBLY</u>	<u>PACKAGE</u>	<u>QUANTITY</u>	<u>FREQUENCY</u>
1992	AUTO. ID.	1.2 Ox Ni	Dallas	Touch Can	100	QUARTERLY
2401	AUTO. ID.	1.2 Ox Ni	Carsem	03 TO92	250	QUARTERLY
2502	AUTO. ID.	1.2 Ox Ni EPROM	Carsem	08 SOIC150	250	QUARTERLY
1259	BAT. BACK.	2.0 Ni	Carsem	16 PDIP	250	QUARTERLY
2434	BAT. MGR.	1.2 Ox Ni	Carsem	03 PR35	250	QUARTERLY
1232	CPU SUP.	3.0 Ox Ni	Anam, PI	08 PDIP	250	QUARTERLY
1232	CPU SUP.	3.0 Ox Ni	Hyundai	16 SOIC	250	QUARTERLY
1233	CPU SUP.	1.2 Ni	Carsem	03 SOT223	250	QUARTERLY
1000	DELAY	1.2 Ni	Omedata	08 PDIP	250	QUARTERLY
1267	DIG. POT.	1.2 Ox Ni	Anam, K	16 SOIC	250	QUARTERLY
1669	DIG. POT.	1.2 Ox Ni EEPROM	Omedata	08 SOIC200	250	QUARTERLY
232	DRIVER	5.0 Ox Ni	Omedata	16 PDIP	250	QUARTERLY
5000T	MICRO	1.2 Ox Ni	Dallas	40 Module	50	QUARTERLY
5002	MICRO	1.2 Ox Ni	Anam, K	80 PQFP	150	QUARTERLY
80C320	MICRO	0.8 Ox Ni	Swire	44PQFP	150	QUARTERLY
80C320	MICRO	0.8 Ox Ni	Anam, K	44 PLCC	150	QUARTERLY
1230	NV. MEMORY	1.2 Ox Ni	Dallas	28 Module	210	QUARTERLY
2250/90	SipStik	PCB	Dallas	PCB	33	QUARTERLY/ALT
2107A	TELECOM	1.2 Ni	Carsem	16 SOIC	250	QUARTERLY
21S07A	TELECOM	0.8 Ni	Anam, K	20 TSSOP	250	QUARTERLY
2165	TELECOM	2.0 Ox	Anam, PI	24 PDIP	250	QUARTERLY
12885	TIME	1.2 Ox Ni	Anam, K	24 SOIC	250	QUARTERLY/ALT
12885	TIME	1.2 Ox Ni	Hyundai	24 PDIP	250	QUARTERLY
12885	TIME	1.2 Ox Ni	Hyundai	28 PLCC	250	QUARTERLY
12887	TIME	1.2 Ox Ni	Dallas	24 Module	210	QUARTERLY
1302	TIME	0.8 Ox Ni (2 MTL)	Anam, K / Hyundai	08 SOIC150	250	QUARTERLY/ALT
1585	TIME	1.2 Ox Ni (2 Poly)	Hyundai	28 SOIC	250	QUARTERLY/ALT
1643	TIME	1.2 Ox Ni	Dallas	28 Module	100	QUARTERLY

Table 1